

## GENERAL DESCRIPTION

Passivated high commutation triacs in a plastic envelope suitable for surface mounting intended for use in circuits where high static and dynamic  $dV/dt$  and high  $dI/dt$  can occur. These devices will commute the full rated rms current at the maximum rated junction temperature without the aid of a snubber.

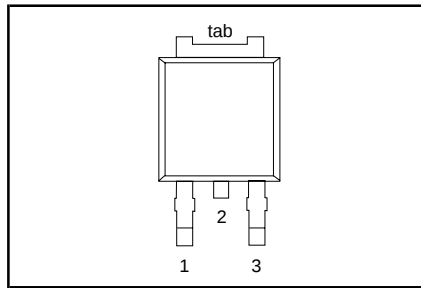
## QUICK REFERENCE DATA

| SYMBOL       | PARAMETER                                                                                    | MAX.                        | MAX.                        | MAX.                        | UNIT |
|--------------|----------------------------------------------------------------------------------------------|-----------------------------|-----------------------------|-----------------------------|------|
| $V_{DRM}$    | <b>BTA204S (or BTA204M)-<br/>BTA204S (or BTA204M)-</b><br>Repetitive peak off-state voltages | <b>500B<br/>500C</b><br>500 | <b>600B<br/>600C</b><br>600 | <b>800B<br/>800C</b><br>800 | V    |
| $I_{T(RMS)}$ | RMS on-state current                                                                         | 4                           | 4                           | 4                           | A    |
| $I_{TSM}$    | Non-repetitive peak on-state current                                                         | 25                          | 25                          | 25                          | A    |

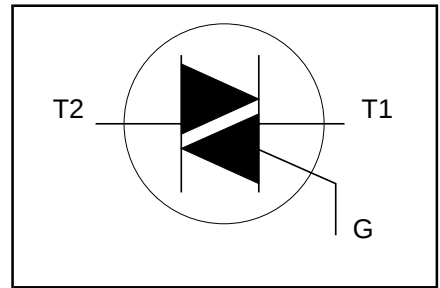
## PINNING - SOT428

| PIN NUMBER | Standard S | Alternative M |
|------------|------------|---------------|
| 1          | MT1        | gate          |
| 2          | MT2        | MT2           |
| 3          | gate       | MT1           |
| tab        | MT2        | MT2           |

## PIN CONFIGURATION



## SYMBOL



## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL       | PARAMETER                            | CONDITIONS                                                                         | MIN. | MAX.                            |                                 |                     | UNIT             |
|--------------|--------------------------------------|------------------------------------------------------------------------------------|------|---------------------------------|---------------------------------|---------------------|------------------|
| $V_{DRM}$    | Repetitive peak off-state voltages   |                                                                                    | -    | <b>-500<br/>500<sup>1</sup></b> | <b>-600<br/>600<sup>1</sup></b> | <b>-800<br/>800</b> | V                |
| $I_{T(RMS)}$ | RMS on-state current                 | full sine wave;<br>$T_{mb} \leq 107^\circ\text{C}$                                 | -    | 4                               |                                 |                     | A                |
| $I_{TSM}$    | Non-repetitive peak on-state current | full sine wave;<br>$T_j = 25^\circ\text{C}$ prior to surge                         | -    | 25                              |                                 |                     | A                |
|              |                                      | $t = 20\text{ ms}$                                                                 | -    | 27                              |                                 |                     | A                |
|              |                                      | $t = 16.7\text{ ms}$                                                               | -    | 3.1                             |                                 |                     | A <sup>2</sup> s |
|              |                                      | $t = 10\text{ ms}$                                                                 | -    | 100                             |                                 |                     | A/μs             |
| $I_{GM}$     | Peak gate current                    | $I_{TM} = 6\text{ A}; I_G = 0.2\text{ A};$<br>$dI_G/dt = 0.2\text{ A}/\mu\text{s}$ | -    | 2                               |                                 |                     | A                |
| $V_{GM}$     | Peak gate voltage                    |                                                                                    | -    | 5                               |                                 |                     | V                |
| $P_{GM}$     | Peak gate power                      |                                                                                    | -    | 5                               |                                 |                     | W                |
| $P_{G(AV)}$  | Average gate power                   | over any 20 ms period                                                              | -    | 0.5                             |                                 |                     | W                |
| $T_{stg}$    | Storage temperature                  |                                                                                    | -40  | 150                             |                                 |                     | °C               |
| $T_j$        | Operating junction temperature       |                                                                                    | -    | 125                             |                                 |                     | °C               |

**1** Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/μs.

## THERMAL RESISTANCES

| SYMBOL         | PARAMETER                                       | CONDITIONS                                             | MIN. | TYP. | MAX. | UNIT |
|----------------|-------------------------------------------------|--------------------------------------------------------|------|------|------|------|
| $R_{th\ j-mb}$ | Thermal resistance<br>junction to mounting base | full cycle                                             | -    | -    | 3.0  | K/W  |
| $R_{th\ j-a}$  | Thermal resistance<br>junction to ambient       | half cycle<br>pcb (FR4) mounted; footprint as in Fig.2 | -    | -    | 3.7  | K/W  |
|                |                                                 |                                                        | -    | 75   | -    | K/W  |

## STATIC CHARACTERISTICS

$T_j = 25\ ^\circ\text{C}$  unless otherwise stated

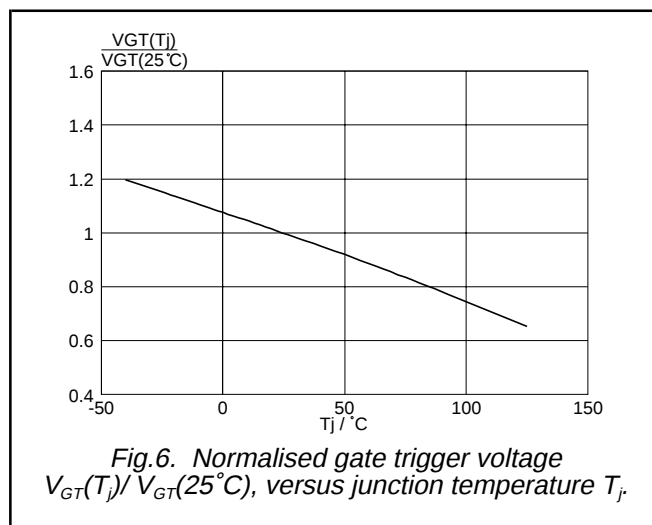
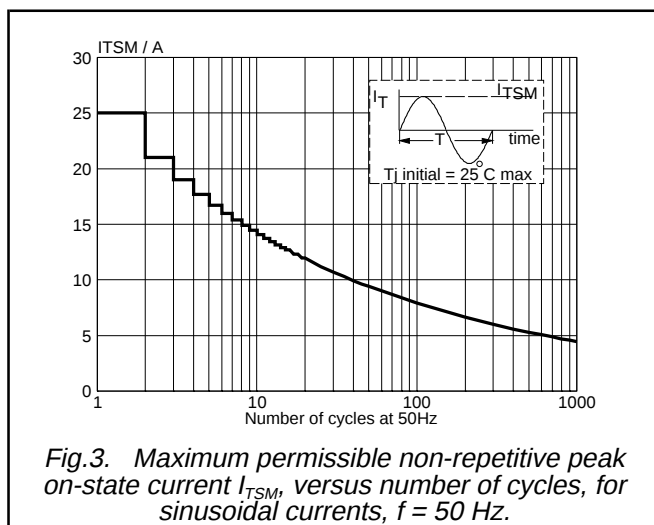
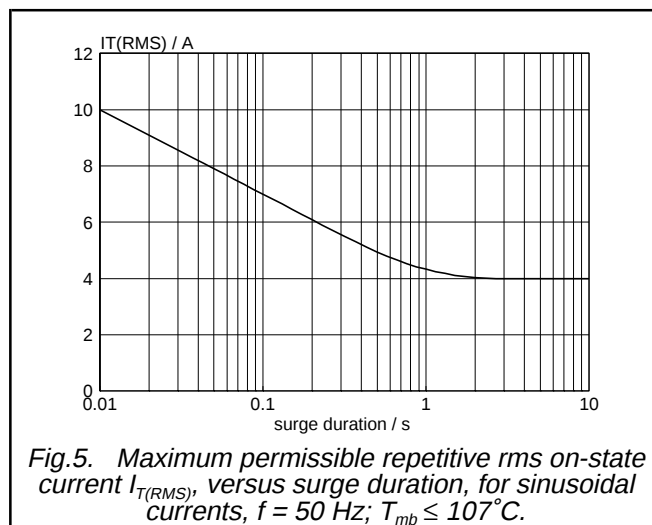
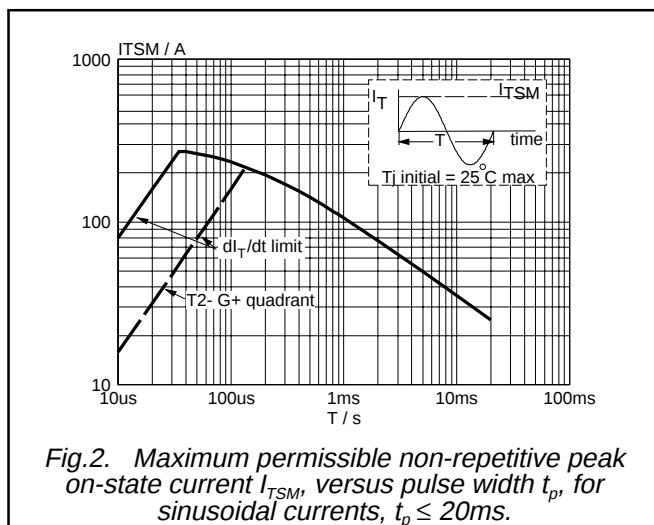
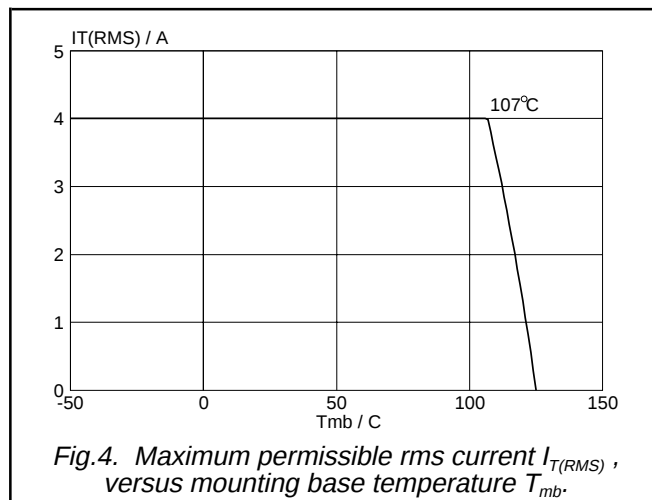
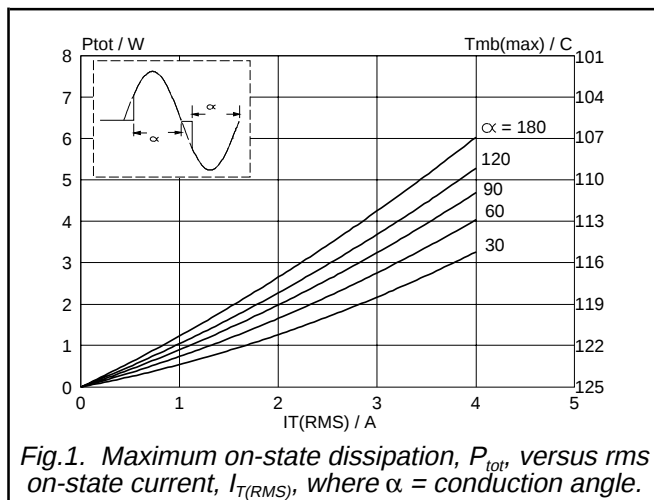
| SYMBOL   | PARAMETER                         | CONDITIONS                                                               | MIN. | TYP. | MAX.        |             | UNIT |
|----------|-----------------------------------|--------------------------------------------------------------------------|------|------|-------------|-------------|------|
|          |                                   | <b>BTA204 (or BTA204M)-</b>                                              |      |      | <b>...B</b> | <b>...C</b> |      |
| $I_{GT}$ | Gate trigger current <sup>2</sup> | $V_D = 12\text{ V}; I_T = 0.1\text{ A}$<br>T2+ G+                        | -    | -    | 50          | 35          | mA   |
|          |                                   | T2+ G-                                                                   | -    | -    | 50          | 35          | mA   |
|          |                                   | T2- G-                                                                   | -    | -    | 50          | 35          | mA   |
| $I_L$    | Latching current                  | $V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$<br>T2+ G+                     | -    | -    | 30          | 20          | mA   |
|          |                                   | T2+ G-                                                                   | -    | -    | 45          | 30          | mA   |
|          |                                   | T2- G-                                                                   | -    | -    | 30          | 20          | mA   |
| $I_H$    | Holding current                   | $V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$                               | -    | -    | 30          | 20          | mA   |
| $V_T$    | On-state voltage                  | $I_T = 5\text{ A}$                                                       | -    | 1.4  | 1.7         |             | V    |
| $V_{GT}$ | Gate trigger voltage              | $V_D = 12\text{ V}; I_T = 0.1\text{ A}$                                  | -    | 0.7  | 1.5         |             | V    |
|          |                                   | $V_D = 400\text{ V}; I_T = 0.1\text{ A};$<br>$T_j = 125\ ^\circ\text{C}$ | 0.25 | 0.4  | -           |             | V    |
| $I_D$    | Off-state leakage current         | $V_D = V_{DRM(max)}; T_j = 125\ ^\circ\text{C}$                          | -    | 0.1  | 0.5         |             | mA   |

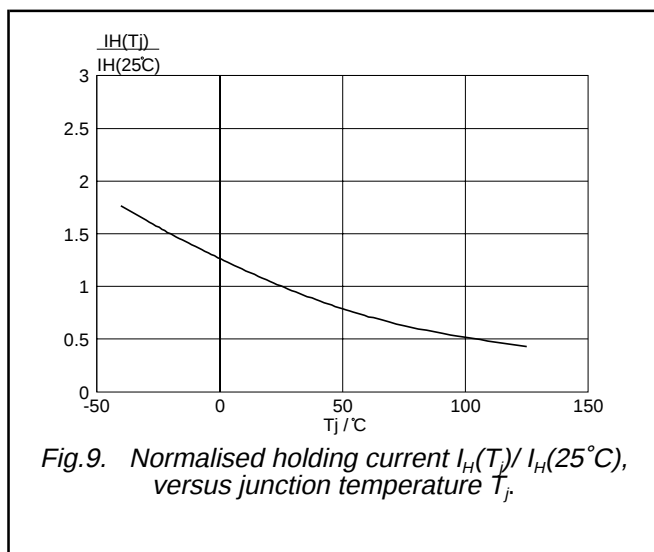
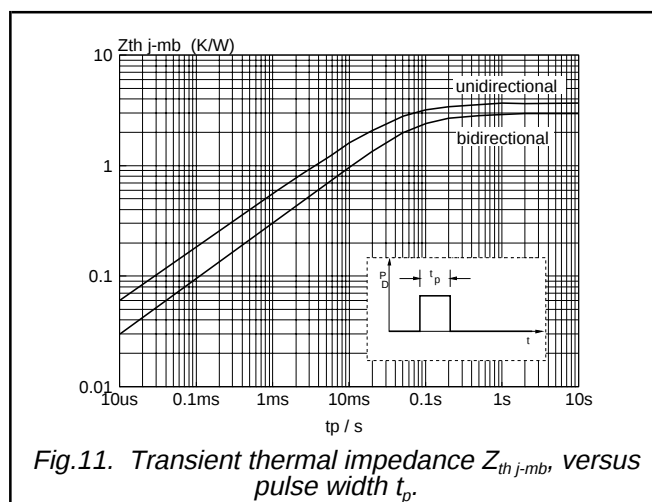
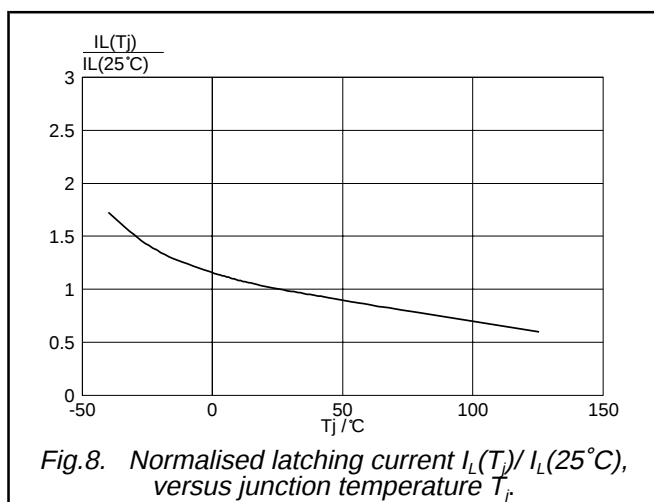
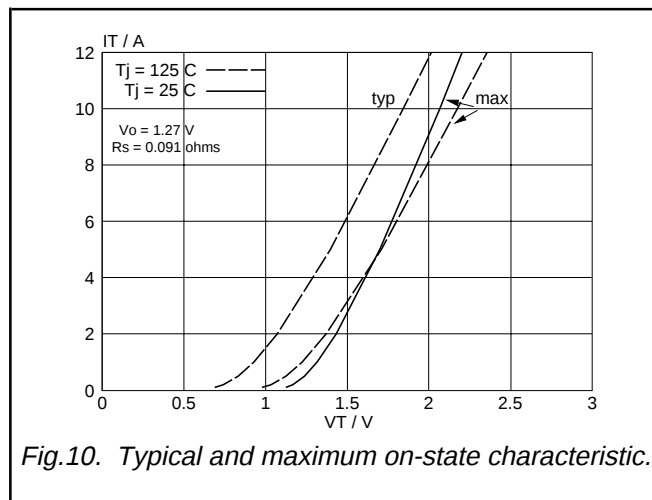
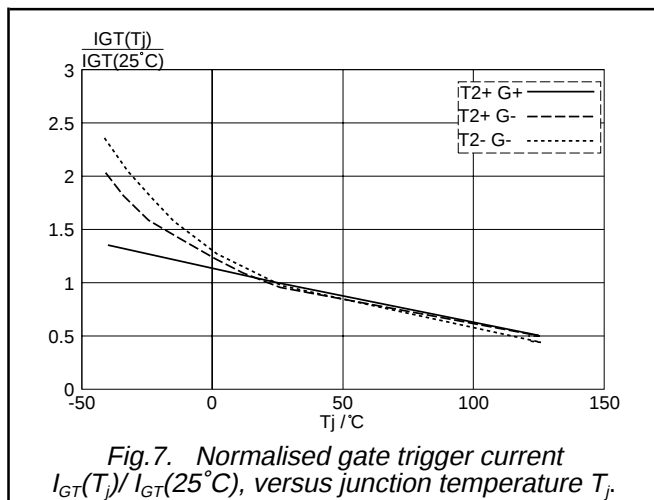
## DYNAMIC CHARACTERISTICS

$T_j = 25\ ^\circ\text{C}$  unless otherwise stated

| SYMBOL        | PARAMETER                                         | CONDITIONS                                                                                                                                 | MIN.        |             | TYP. | UNIT             |
|---------------|---------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|-------------|-------------|------|------------------|
|               |                                                   | <b>BTA204S (or BTA204M)-</b>                                                                                                               | <b>...B</b> | <b>...C</b> |      |                  |
| $dV_D/dt$     | Critical rate of rise of<br>off-state voltage     | $V_{DM} = 67\% V_{DRM(max)}; T_j = 125\ ^\circ\text{C};$<br>exponential waveform; gate open circuit                                        | 1000        | 1000        | -    | V/ $\mu\text{s}$ |
| $dI_{com}/dt$ | Critical rate of change of<br>commutating current | $V_{DM} = 400\text{ V}; T_j = 125\ ^\circ\text{C}; I_{T(RMS)} = 4\text{ A};$<br>$dV_{com}/dt = 20\text{ V}/\mu\text{s};$ gate open circuit | 6           | 3           | -    | A/ms             |
| $t_{gt}$      | Gate controlled turn-on<br>time                   | $I_{TM} = 12\text{ A}; V_D = V_{DRM(max)}; I_G = 0.1\text{ A};$<br>$dI_G/dt = 5\text{ A}/\mu\text{s}$                                      | -           | -           | 2    | $\mu\text{s}$    |

<sup>2</sup> Device does not trigger in the T2-, G+ quadrant.

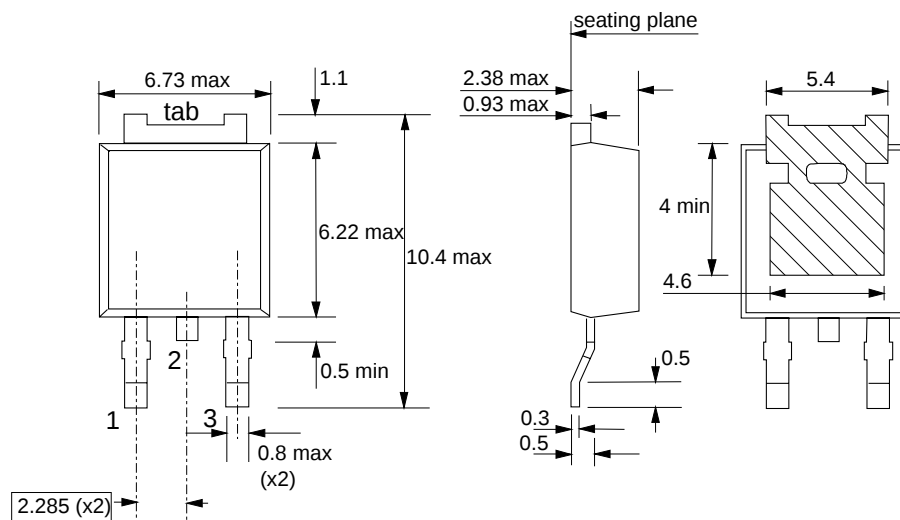




## MECHANICAL DATA

*Dimensions in mm*

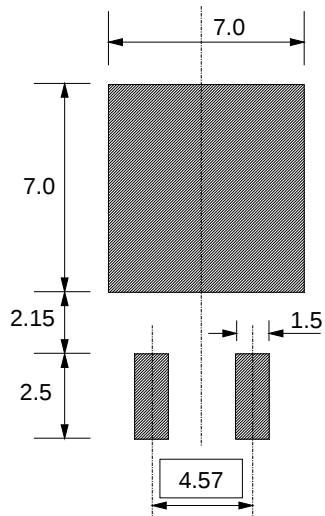
*Net Mass: 1.1 g*



*Fig.12. SOT428 : centre pin connected to tab.*

## MOUNTING INSTRUCTIONS

*Dimensions in mm*



*Fig.13. SOT428 : minimum pad sizes for surface mounting.*

### Notes

1. Plastic meets UL94 V0 at 1/8".